Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSIV)

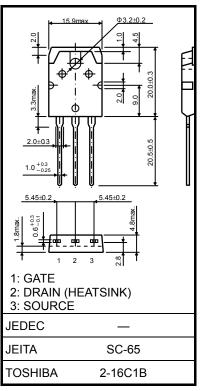
2SK4207

Swiching Regulator Applications

- Low drain-source ON-resistance: R_{DS} (ON) = 0.78 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 11 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 720 V)
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	900	V
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	900	V
Gate-source voltage		V _{GSS}	±30	V
Drain current	DC (Note 1)	I _D	13	Α
	Pulse (Note 1)	I _{DP}	39	Α
Drain power dissipation	n (Tc = 25°C)	P_{D}	150	W
Single pulse avalanche	e energy (Note 2)	E _{AS}	491	mJ
Avalanche current		I _{AR}	13	Α
Repetitive avalanche e	nergy (Note 3)	E _{AR}	15	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature ra	ange	T _{stg}	-55 to 150	°C



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

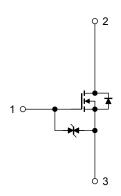
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	0.833	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 5.3 mH, R_G = 25 Ω , I_{AR} = 13 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



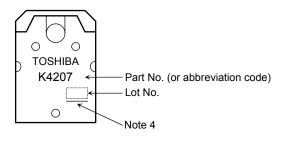
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I _{GSS}	V _{GS} = ±30 V, V _{DS} = 0 V	_	_	±10	μА
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V	_	_	100	μА
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	900	_	_	V
Gate threshold v	oltage/	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N-resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 6.5 A	_	0.78	0.95	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 6.5 A	5.0	11	_	S
Input capacitano	e	C _{iss}		_	2790	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	25	_	pF
Output capacitance		Coss]		300	_	
Switching time	Rise time	t _r	$V_{GS} = \frac{10V}{0V} = \frac{I_{D}=6.5}{V_{Out}} = V_{Out}$ $V_{DD}=400V$ $V_{DD}=400V$ $V_{DD}=400V$	_	53	_	
	Turn-on time	t _{on}		_	88	_	ns
	Fall time	t _f		_	43	_	115
	Turn-off time	t _{off}			165		
Total gate charg plus gate-drain)	, , , , , , , , , , , , , , , , , , ,		_	45	_		
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 13 \text{ A}$		32		nC
Gate-drain ("miller") Charge		Q _{gd}		_	13		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	13	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	39	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 13 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 13 A, V _{GS} = 0 V		1400		ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A /μs	_	24	_	μС

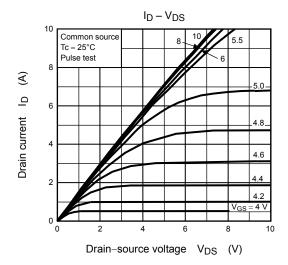
Marking

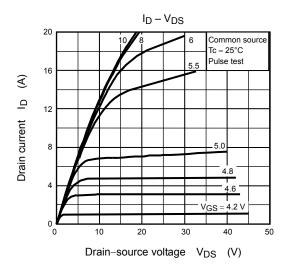


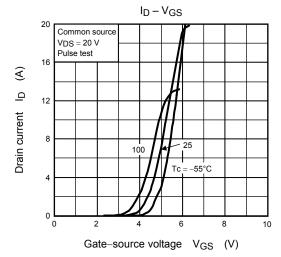
Note 4: A line under a Lot No. identifies the indication of product Labels.

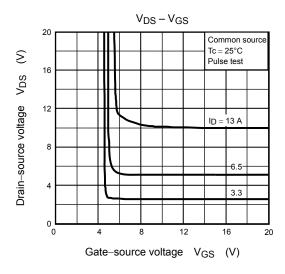
[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

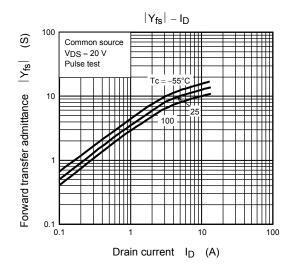
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

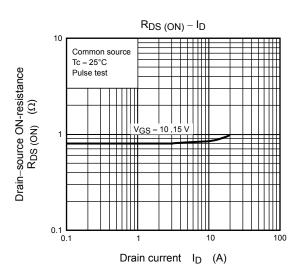


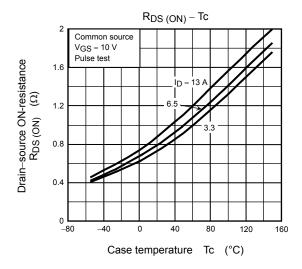


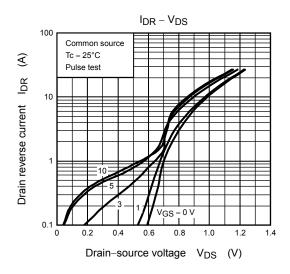


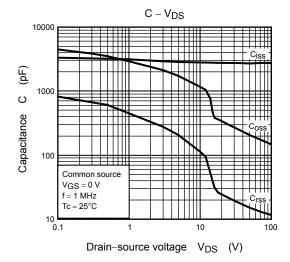


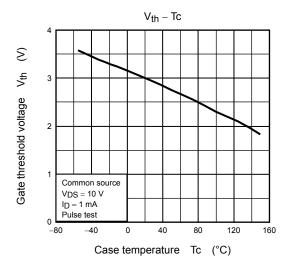


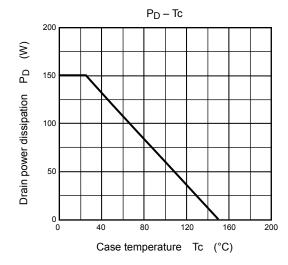


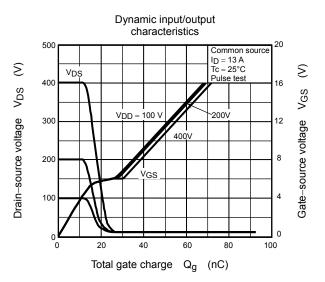


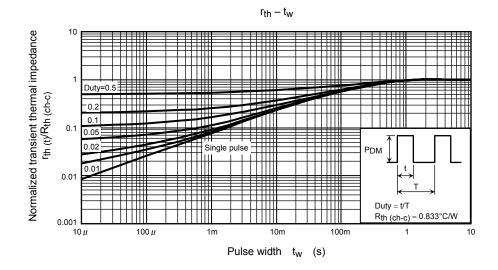




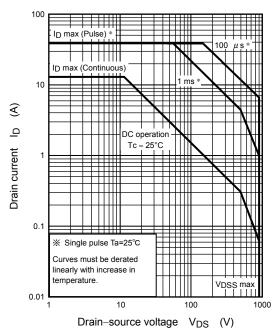


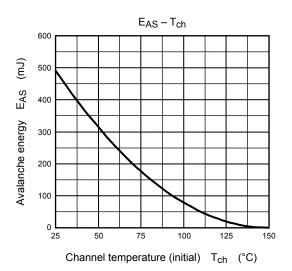


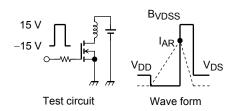




SAFE OPERATING AREA







$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 5.3~mH \end{aligned}$$

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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